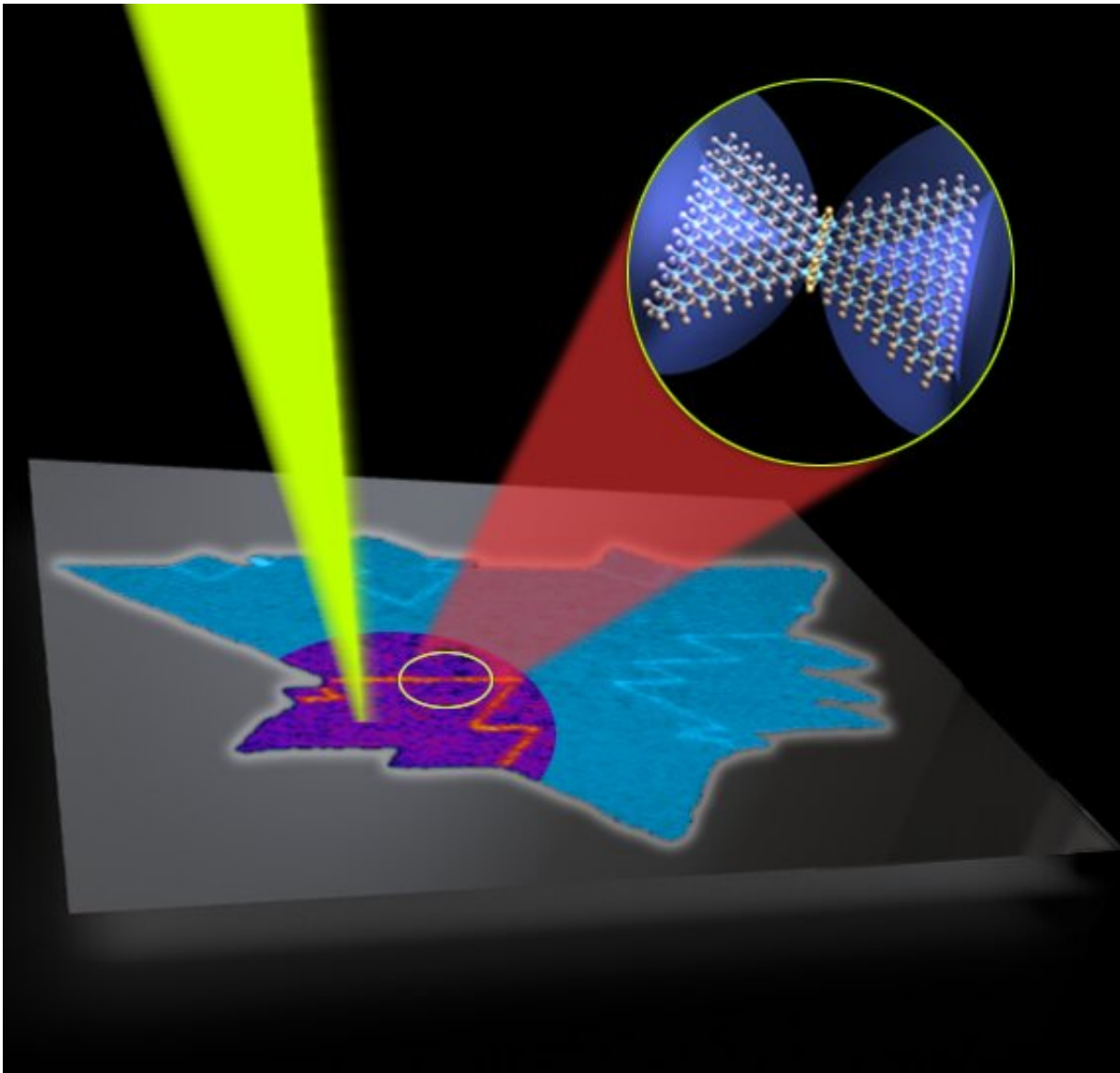


Method detects defects in 2-D materials for future electronics, sensors

January 28 2020, by Walt Mills



A laser beam (yellow) reflects off a 2D material (orange) highlighting a grain

boundary defect in the atomic lattice. Credit: MRI/Penn State

To further shrink electronic devices and to lower energy consumption, the semiconductor industry is interested in using 2-D materials, but manufacturers need a quick and accurate method for detecting defects in these materials to determine if the material is suitable for device manufacture. Now a team of researchers has developed a technique to quickly and sensitively characterize defects in 2-D materials.

Two-dimensional materials are atomically thin, the most well-known being graphene, a single-atom-thick layer of carbon atoms.

"People have struggled to make these 2-D materials without defects," said Mauricio Terrones, Verne M. Willaman Professor of Physics, Penn State. "That's the ultimate goal. We want to have a 2-D material on a four-inch wafer with at least an acceptable number of defects, but you want to evaluate it in a quick way."

The researchers'—who represent Penn State, Northeastern University, Rice University and Universidade Federal de Minas Gerais in Brazil—solution is to use [laser light](#) combined with second harmonic generation, a phenomenon in which the frequency of the light shone on the material reflects at double the original frequency. They add dark field imaging, a technique in which extraneous light is filtered out so that defects shine through. According to the researchers, this is the first instance in which dark field imaging was used, and it provides three times the brightness of the standard bright field imaging method, making it possible to see types of defects previously invisible.

"The localization and identification of defects with the commonly used bright field second harmonic generation is limited because of

interference effects between different grains of 2-D materials," said Leandro Mallard, a senior author on a recent paper in *Nano Letters* and a professor at Universidade Federal de Minas Gerais. "In this work we have shown that by the use of dark field SHG we remove the interference effects and reveal the grain boundaries and edges of semiconducting 2-D materials. Such a novel technique has good spatial resolution and can image large area samples that could be used to monitor the quality of the material produced in industrial scales."

Vincent H. Crespi, Distinguished Professor of Physics, Materials Science and Engineering, and Chemistry, Penn State, added, "Crystals are made of atoms, and so the defects within crystals—where atoms are misplaced—are also of atomic size.

"Usually, powerful, expensive and slow experimental probes that do microscopy using beams of electrons are needed to discern such fine details in a material," said Crespi. "Here, we use a fast and accessible optical method that pulls out just the signal that originates from the [defect](#) itself to rapidly and reliably find out how 2-D materials are stitched together out of grains oriented in different ways."

Another coauthor compared the technique to finding a particular zero on a page full of zeroes.

"In the dark field, all the zeroes are made invisible so that only the defective zero stands out," said Yuanxi Wang, assistant research professor at Penn State's Materials Research Institute.

The [semiconductor industry](#) wants to have the ability to check for defects on the production line, but 2-D materials will likely be used in sensors before they are used in electronics, according to Terrones. Because 2-D materials are flexible and can be incorporated into very small spaces, they are good candidates for multiple sensors in a

smartwatch or smartphone and the myriad of other places where small, flexible sensors are required.

"The next step would be an improvement of the experimental setup to map zero dimension defects—atomic vacancies for instance—and also extend it to other 2-D materials that host different electronic and structural properties," said lead author Bruno Carvalho, a former visiting scholar in Terrones' group,

More information: Martin Heilmann et al, Influence of Proximity to Supporting Substrate on van der Waals Epitaxy of Atomically Thin Graphene/hexagonal Boron Nitride Heterostructures, *ACS Applied Materials & Interfaces* (2020). [DOI: 10.1021/acsami.9b21490](https://doi.org/10.1021/acsami.9b21490)

Provided by Pennsylvania State University

Citation: Method detects defects in 2-D materials for future electronics, sensors (2020, January 28) retrieved 28 April 2024 from <https://phys.org/news/2020-01-method-defects-d-materials-future.html>

<p>This document is subject to copyright. Apart from any fair dealing for the purpose of private study or research, no part may be reproduced without the written permission. The content is provided for information purposes only.</p>
--